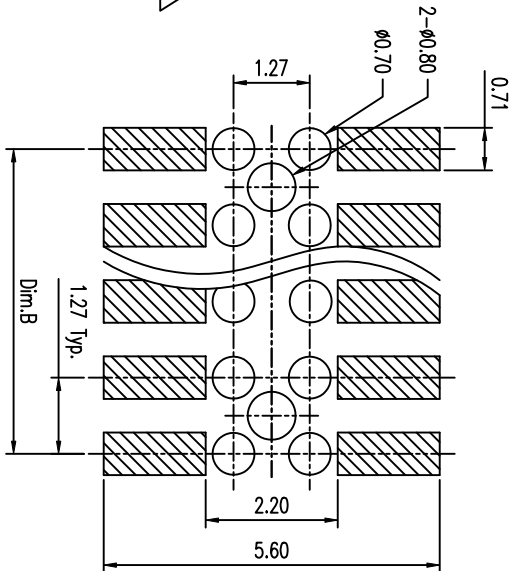
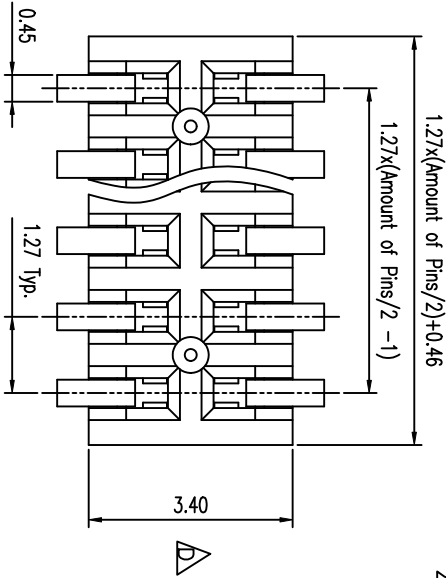
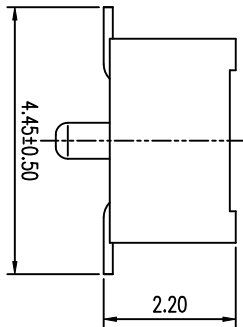
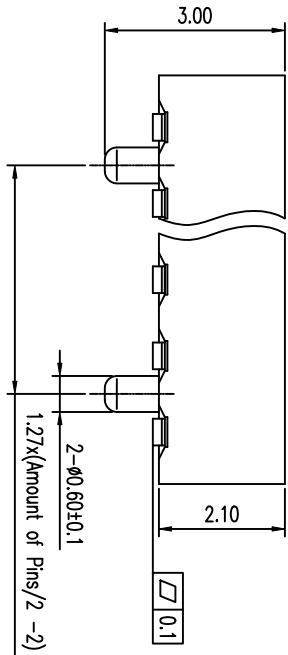
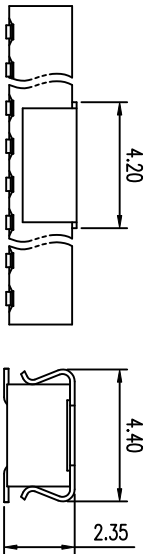




Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm

- NOTE:
1. MATERIAL, HOUSING: HIGH TEMP PLASTIC, UL94-V0
TERMIN AL: COPPER ALLOY , T=0.15MM
CAP: STAINLESS STEEL , T=0.1MM
 2. FINISH: TERMINAL: GOLD AT CONTACT
G/F OVER 1.27um(50u")MIN Ni OVER ALL
 3. SPEC: PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
 4. THE HSG. WILL WITHSTAND EXPOSURE TO 260C PEAK TEMP. FOR 10 SEC. IN A CONVECTION, INFRA-RED OR VAPOR PHASE REFLOW OVEN.
 5. PRODUCT NUMBERING: 20021323 - X 0 0 XX X X LF

LEAD FREE
PLATING:
1: GOLD FLASH ALL OVER
4: 0.25um(10U")GOLD AT CONTACT
8: 0.76um(30U")GOLD AT CONTACT
PACKING
D: TUBE+ CAP
C: REEL+ CAP
(10,20,30,40,42,70 PIN)
T: TUBE
PIN COUNT
4,6,8,....,80
(EVERY EVEN PIN)
0: WITHOUT POST
1: WITH POST



With Cap
Scale 4:1

mat'l. code		tolerances unless otherwise specified		CUSTOMER COPY		FCI	
lfr	ecn no	dr	date	line ar	projection	title	www.fciconnect.com
A	109-1117	S.LIN	09/15/09	.XX ± 0.25	MM	1.27X1.27MM BTB RECEPTACLE	
B	T10-0020	S.LIN	01/20/10	.XXX ± 0.10		SMT, BOTTOM ENTRY	
C	T10-0120	S.LIN	10-07-30	angles 0° ± 2°			
D	ELX7004402	S.LIN	11-07-11	dr	STERLING LIN	09/15/09	
				engr	STERLING LIN	09/15/09	
				chr	GARY HSIEH	09/15/09	
				oppl	JOSEPH HSIA	09/15/09	
sheet index	revision	D	1		scale	NA	
						A4	
					product family	585	
					size dwg no	20021323	
					code	TWN	
					sheet	1 of 1	

1 2

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4

1 2

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